



Product Change Notification

Change Notification #: 115306 - 00
Change Title: Intel® Server Board S2600CW2R,
Intel® Server Board S2600CW2SR,
Intel® Server Board S2600CWTR,
Intel® Server Board S2600CWTSR,
PCN 115306-00, Product Material,
Replacement of BMC DDR3 chip
Date of Publication: February 14, 2017

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	Mar 03, 2017
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following change:

Intel is replacing the current BMC DDR3 memory chip K4B1G1646G-BCH9 (G38649-001) (end of life) with new K4B1G1646I-BCK0 (J47782-001). Intel reports validation completed with passing results. The replacement component is identical in form factor and function.

Current DDR3 (G38649-001)



New DDR3 (J47782-001)



Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason, Intel recommends that the customers perform a standard level of evaluation.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
DBS2600CW2R	943803	H67035-224	H12881-270	H67035-225	H12881-271
DBS2600CW2SR	943804	H43725-224	H12883-270	H43725-225	H12883-271
DBS2600CWTR	943805	H43723-224	H12882-270	H43723-225	H12882-271
DBS2600CWTSR	943806	H43727-224	H12884-270	H43727-225	H12884-271

PCN Revision History:

Date of Revision:
February 14, 2017

Revision Number:
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Reason:
Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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